

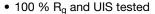
# N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	30			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00120			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00185			
Q <sub>g</sub> typ. (nC)	28.7			
I <sub>D</sub> (A)	80 a, g			
Configuration	Single			

### **FEATURES**

- TrenchFET® Gen IV power MOSFET
- Excellent R<sub>DS</sub> Q<sub>g</sub> Figure-of-Merit (FOM) for switch-mode power supplies



· Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

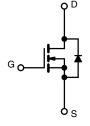


HALOGEN

**FREE** 

### **APPLICATIONS**

- Synchronous buck converter
- High power density DC/DC
- · Synchronous rectification
- · Load switch
- OR-ing



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiRA62DP-T1-RE3

ABSOLUTE MAXIMUM RATING	<b>is</b> (T <sub>A</sub> = 25 °C, u	nless other	wise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	30	V	
Gate-source voltage		$V_{GS}$	+16 / -12		
	T <sub>C</sub> = 25 °C		80 <sup>a</sup>		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1 .	80 <sup>a</sup>	1	
	T <sub>A</sub> = 25 °C	l <sub>D</sub>	51.4 <sup>b, c</sup>	Ì	
	T <sub>A</sub> = 70 °C		40.9 <sup>b, c</sup>	1 ,	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	300	- A	
	T <sub>C</sub> = 25 °C		59.7	Ī	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	4.7 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	30	1	
Single pulse avalanche energy L = 0.1 mH		E <sub>AS</sub>	45	mJ	
	T <sub>C</sub> = 25 °C		65.7		
Manian and a sure displacement	T <sub>C</sub> = 70 °C	1 5	42	ĺ ,,,	
Maximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	5.2 <sup>, c</sup>	W	
	T <sub>A</sub> = 70 °C	1	3.3 b, c	1	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) c			260	1	

THERMAL RESISTANCE RATING	S				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	20	24	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.5	1.9	C/VV

- Package limited
- b. Surface mounted on 1" x 1" FR4 board
- See solder profile (<a href="www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

  Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

  Maximum under steady state conditions is 62.5 °C/W

- $T_C = 25 \,^{\circ}C$



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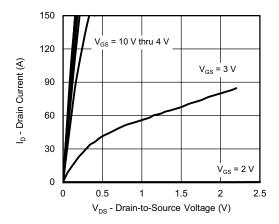
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> =10 mA	-	17	-	>//00
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-4.3	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	-	2.2	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +16 / -12 \text{ V}$	-	-	100	nA
Zero gete voltage due in comment		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	40	-	-	Α
Duein and an atota maintaine 3	Б	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	0.00100	0.00120	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	0.00145	0.00185	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A	-	95	-	S
Dynamic <sup>b</sup>						
Input capacitance	C <sub>iss</sub>		-	4460	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	1615	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	202	-	
Tatal asta alcauna	0	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	61.5	93	
Total gate charge	$Q_g$		-	28.7	44	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	10	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	5.8	-	
Gate resistance	$R_g$	f = 1 MHz	0.2	0.7	1.3	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	12	24	
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega, I_D \cong 10 \text{ A},$	-	21	42	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	26	52	
Fall time	t <sub>f</sub>		-	10	20	
Turn-on delay time	t <sub>d(on)</sub>		-	25	50	ns
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_L = 1.5 \Omega, \text{ I}_D \cong 10 \text{ A},$	-	39	78	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$	-	30	60	
Fall time	t <sub>f</sub>		-	21	42	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous source-drain diode current	IS	T <sub>C</sub> = 25 °C	-	-	59.7	^
Pulse diode forward current	I <sub>SM</sub>		-	-	300	Α
Body diode voltage	$V_{SD}$	$I_S = 5 A, V_{GS} = 0 V$	-	0.72	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	16	112	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 15 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	66	132	nC
Reverse recovery fall time	ta	$T_J = 25  ^{\circ}\text{C}$	-	25	-	ns
Reverse recovery rise time	t <sub>b</sub>		_	31	-	

### Notes

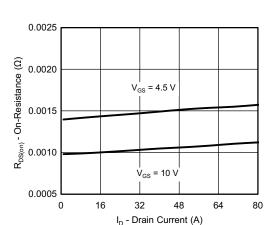
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. T<sub>CASE</sub> = 25 °C. Expected voltage stress during 100 % UIS test. Production datalog is not available

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

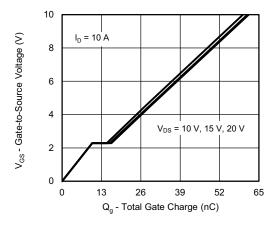




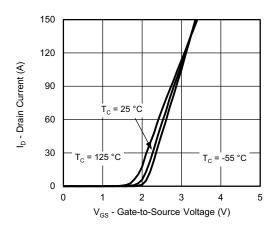
### **Output Characteristics**



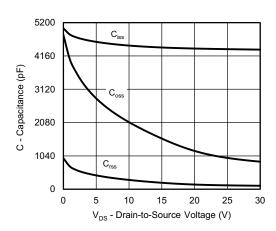
On-Resistance vs. Drain Current and Gate Voltage



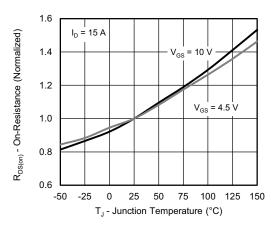
**Gate Charge** 



**Transfer Characteristics** 

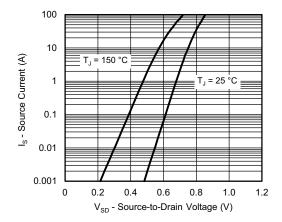


Capacitance

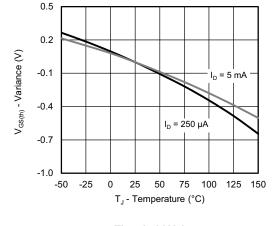


On-Resistance vs. Junction Temperature

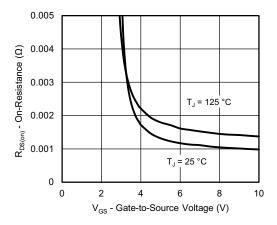




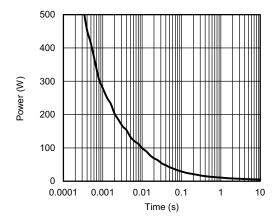
Source-Drain Diode Forward Voltage



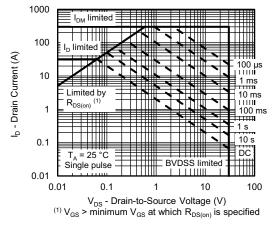
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

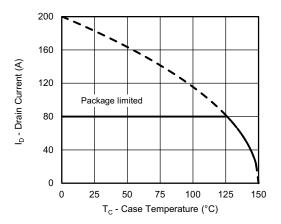


Single Pulse Power, Junction-to-Ambient

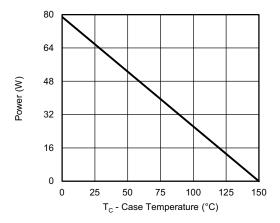


Safe Operating Area, Junction-to-Ambient

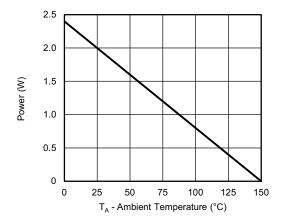




### Current Derating a





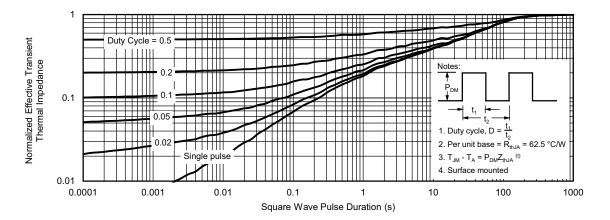


Power, Junction-to-Ambient

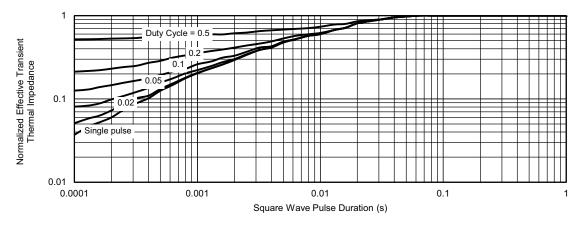
### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?75882">www.vishay.com/ppg?75882</a>.



DWG: 5881

PowerPAK® SO-8, (Single/Dual)

# Notes 1. Inch will govern. 2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

Backside View of Dual Pad

DIM.		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX		
Α	0.97	1.04	1.12	0.038	0.041	0.044		
A1		-	0.05	0	_	0.002		
b	0.33	0.41	0.51	0.013	0.016	0.020		
С	0.23	0.28	0.33	0.009	0.011	0.013		
D	5.05	5.15	5.26	0.199	0.203	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.56	3.76	3.91	0.140	0.148	0.154		
D3	1.32	1.50	1.68	0.052	0.059	0.066		
D4		0.57 typ.			0.0225 typ.			
D5		3.98 typ.			0.157 typ.			
Е	6.05	6.15	6.25	0.238	0.242	0.246		
E1	5.79	5.89	5.99	0.228	0.232	0.236		
E2	3.48	3.66	3.84	0.137	0.144	0.151		
E3	3.68	3.78	3.91	0.145	0.149	0.154		
E4		0.75 typ.		0.030 typ.				
е		1.27 BSC		0.050 BSC				
K		1.27 typ.			0.050 typ.			
K1	0.56	-	-	0.022	-	-		
Н	0.51	0.61	0.71	0.020	0.024	0.028		
L	0.51	0.61	0.71	0.020	0.024	0.028		
L1	0.06	0.13	0.20	0.002	0.005	0.008		
θ	0°	-	12°	0°	-	12°		
W	0.15	0.25	0.36	0.006	0.010	0.014		
М		0.125 typ.			0.005 typ.			

Revison: 13-Feb-17 1 Document Number: 71655



## RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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